

TPL7407L7-Channel Relay and Inductive Load Sink Driver EVM

1 Overview

The TPL7407LEVM is a 7-Channel Relay and Inductive Load Sink Driver evaluation module that demonstrates the TPL7407LDR integrated circuit from Texas Instruments (TI).

The TPL7407LDR is a high-performance peripheral driver designed to drive loads of many types including: relays, stepper motors, lamps, and light emitting diodes.

The EVM is configured with seven push buttons that supply input to the TPL7407L driver and seven relays are driven by the TPL7407L outputs. A four terminal block can be connected to external power supplies to provide input and relay power. All of the TPL7407L input and output pins are accessible for external connection.

1.1 TPL7407LEVM Features

- Seven numbered push buttons control input for device testing.
- Seven numbered light emitting diodes indicate relay contact closure.
- Three 0.1" spaced post connector ports that allow access to all input pins, output pins, and relay contacts.
- Three open locations, per channel, on the circuit board for user supplied components.
- Onboard relay loads that can be disconnected by removing surface mounted 0Ω resistors.
- A large device clearance area that allows the use of small profile temperature forcing equipment.

Table 1. TPL7407LEVM Specification

Key Parameters	
Input Supply Voltage:	0V – 5.5V
Relay Supply Voltage:	8.5V – 24V
Output Current:	0mA to 500mA
Number of Channels:	7
Onboard Load:	Seven OMRON G5NB relays

G5NB specs

- Nominal coil resistance is 2,880Ω
- Nominal coil current is 8.3mA
- Nominal coil voltage is 24V
- Pickup voltage < 75% Nominal
- Dropout voltage > 10% Nominal
- Maximum coil voltage 180% Nominal

CAUTION: Applying voltages above the limitations given in [Table 1](#) may cause permanent damage to your hardware.

Gerber (layout) files are available at www.ti.com.

The EVM includes mating connectors for input, output, and contact pins.

PCB Key Map

Physical structure for the TPL7407LEVM is illustrated in [Figure 1](#).

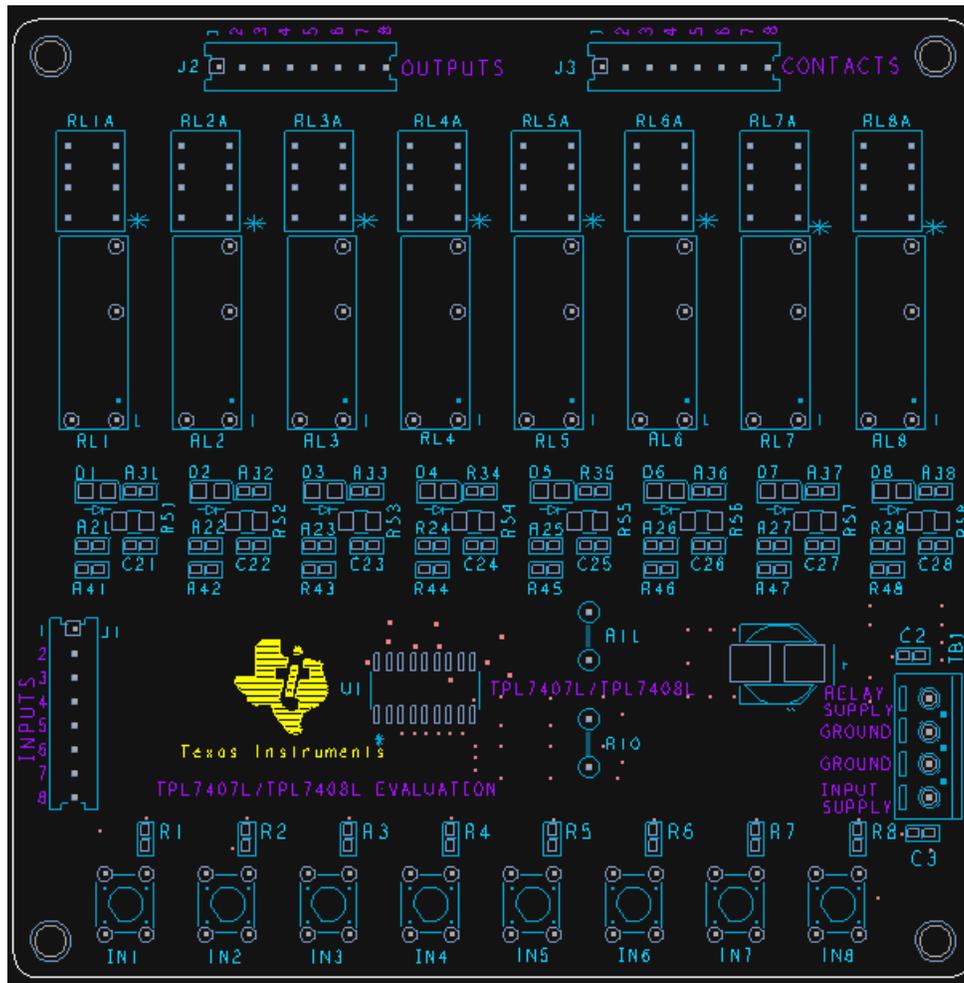


Figure 1. Physical Structure for the TPL7407LEVM (Approximate Layout)

2 Quick Setup Guide

This section describes the setup to quickly check the functionality of TPL7407LEVM.

2.1 Electrostatic Discharge Warning

Many of the components on the TPL7407LEVM are susceptible to damage by electrostatic discharge (ESD). Customers are advised to observe proper ESD handling precautions when unpacking and handling the EVM, including the use of a grounded wrist strap at an approved ESD workstation.

CAUTION: Failure to observe ESD handling procedures may result in damage to EVM components.

Unpacking the EVM

After opening the TPL7407LEVM package, check to ensure that the following items are included:

- 1 pc. TPL7407LEVM board using one TPL7407LDR
- 3 pc. Eight pin insulation displacement connectors that accept AWG 22 insulated wire.

Power Supply Setup

A 8.5V - 24V power supply capable of 500 mA of current is required.

Connect the positive power supply lead to the “Input Supply” on TB1-1 and also connect it to the “Relay Supply” on TB1-4. Connect the negative power supply lead to either of the two ground connections on TB1-2 or TB1-3.

It is important to connect the power supply correctly because opposite supply polarity will damage the EVM.

Turn the power supply on. At this time, the EVM light emitting diodes (LEDS) should be off and no current should be flowing from the power supply. The TPL7407L consumes no power when all seven channels are off.

Press the pushbuttons labeled IN1 through IN7 one at a time. When pressed the corresponding relay will click as the contacts engage and the LED will illuminate.

Releasing a pushbutton will disengage the corresponding relay contacts and extinguish the LED.

If all seven buttons operate as previously described, then the TPL7407LEVM passes functional testing.

3 EVM Theory and Operation

The following single channel schematic is representative of the seven identical driver channels.

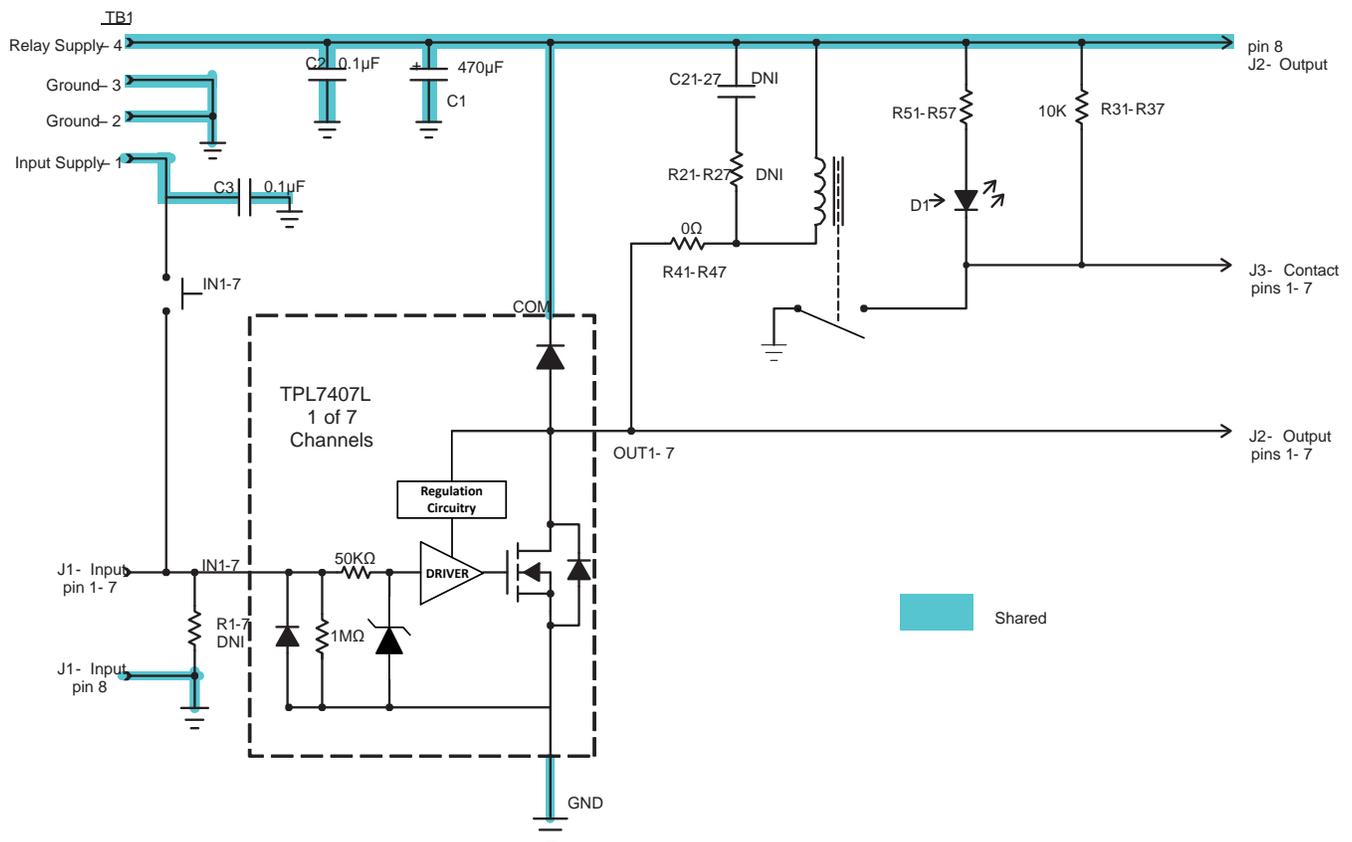


Figure 2. Single Channel Schematic

The TPL7407LEVM is designed to accept an “Input Supply” on TB1-1 with a voltage range of 1.8V to 5.5V and a “Relay Supply” on TB1-4 with a voltage range ideally set to 24V ±10%, but will still operate with a minimum voltage of 8.5V and a maximum voltage of 40V.

When none of the buttons are pressed, the TPL7407L inputs will be open circuit and the internal resistors in the TPL7407L will ensure zero volts on the inputs. With the inputs low, the TPL7407L output pins will set to a high impedance state; therefore, no current will flow through the relay coils. The relay contact will not be engaged and the voltage on the J3-Contact pins 1 to 7 will be pulled up to the relay supply voltage by a 10k Ω resistor on the PCB.

Pressing one of the input buttons, labeled IN1 to IN7, will apply the input voltage supply on TB1-1 to the corresponding input pin on the TPL7407L. The internal resistor on the TPL7407L input pin will draw a small current proportional to the input voltage. The nominal current is input voltage divided by 1M Ω , it can also be expressed as the ratio, 1 μ A/V. The NMOS switch inside the TPL7407L turns on providing a low resistance path from output to ground. This completes the circuit and current flows from the relay supply through the G5NB relay coil and through the TPL7407L output switch to ground and finally back through the relay supply return lead. The relay coil current will engage the relay contacts. The relay contacts will short the corresponding J3 "contact" pin to ground. It will also complete the corresponding LED circuit and the LED will illuminate.

Releasing one of the input buttons, labeled IN1 to IN7, will remove the input voltage from the corresponding input pin on the TPL7407L. The internal resistor on the TPL7407L input pin will decrease the input voltage to zero. The NMOS switch inside the TPL7407L turns off breaking the current path for the relay coil. Since the coil is an inductor, the current cannot change in zero time. The coil voltage will change polarity resulting in a TPL7407L output voltage that is greater than the relay supply voltage. This will forward bias the diode inside the TPL7407L passing current back to the relay supply voltage. This current will continue until the stored coil energy is depleted. The relay contacts will disengage and the short on the J3-Contact pin will be removed and the pin voltage will increase back to the relay supply voltage. The LED circuit will be open, thus extinguishing the LED.

The voltage on the output pins is always available on the J2-Output connector pins 1-7. Pin 8 is connected to the COM pin on the TPL7407L and the relay supply voltage on TB1 pin 4. The J2-Output connector can be used to measure the output voltage. It can also be used to add additional loads to the TPL7407L output pins. The series resistance between the J2-output connector and the TPL7407L is approximately 20 m Ω . The onboard AGQ2003 relay coils can be removed from the TPL7407L by removing the seven 0 Ω resistors at locations R41 to R47.

The voltage on the input pins is always available on the J1-Input connector pins 1-7. Pin 8 is connected to the GND pin on the TPL7407L and the ground voltage on TB1 pins 2 & 3. The J1-Input connector can be used to measure the input voltage. It can also be used to inject external signals onto the TPL7407L input pins.

Three user supplied components, per channel, can be added if needed. All three circuit board footprints are SMD 0603 sized. The first location, R1 to R7, allows adding a resistor from each input to ground. The second, R21 to R27, and third location, C21 to C27, are in series with each other and parallel with the G5NB relay coils.

The terminal block, TB1, provides power for the input pushbuttons and relay coils. When directly controlling the inputs using the J1-Input connector, the input source on TB1 pin1 may be disconnected.

The TPL7407L EVM board has seven identical channels. The single channel schematic is easier to read than the complete schematic. The TPL7407L single model functional diagram is enclosed by dotted lines. The input pin has a 1M Ω resistor that keeps the driver off when no input is disconnected or put in to a high impedance state. The NMOS transistor sinks to a shared ground connection when the input voltage is applied. When the load is inductive and the NMOS turns off, the output voltage will increase beyond the relay supply voltage and inductor current will continue to flow through the free wheeling diode to the COM pin until the inductor is discharged.

Resistors R41 through R47 can be removed to isolate the output from the relay coils when external load or automated test equipment is provided through the J2-Output connector.

The relay is an G5NB relay with a 2,880 Ω , 24V, 8.3mA nominal coil. The pull-in voltage is less than 2.25V (3V \times 75%) and the drop out voltage is greater than 0.3V. The maximum coil voltage is 43.2V (24V \times 180%).

The relay contact when open will allow the J3-Contact pin to rise to the Relay supply voltage. The voltage on J3-Contact connector can be measured by any high impedance (>100k Ω) measuring device. When the contacts close the J2-Contact pin will be pulled down to ground potential.

The TPL7407L output pins 16 to 10 are connected to relays RL1 to RL7 and J2-Output port pins 1 -7 (pin 8 is relay coil power sense).

The TPL7407L COM, pin 9, is connected to the relay supply on TB1. This pin connects to the cathodes of free wheeling diodes for each output. It provides a discharge path when the inductive load is turned off.

The inputs can be fully controlled by external test equipment using the J1-Input Port. The outputs can be measured by external test equipment using the J2-Output Port. If relay supply voltage, TPL7407L COM pin, exceeds 40V or full external control is required, then the relay coils should be disconnected by removing the zero ohm resistors labeled R41 to R47.

The TPL7407LEVM has open 0603 foot prints for input resistors to ground as R11 to R17, coil wave shaping resistor and capacitors as R31 to R37 and C31 to C37. The TPL7407L does not require these components.

Increasing output load using onboard relays: Shorting two or more of the J2 pins 1-7 (output port) will parallel the TPL7407L outputs and relay coils. By activate just one of the inputs for the shorted output channels will cause a single output to drive multiple relay coil loads. Two coils typically uses 16.6mA and three coils typically use 24.9mA.

4 TPL7407LEVM Performance Testing Using Lab Equipment

Datasheet electrical characterization parameters can be measured using the following test setups. Setups for both standard EVM boards and modified EVM boards that have R41 to R47 removed to disconnect the onboard relay loads. It is acceptable to keep some channels "standard" (R4x installed) and other channels "modified" (R4x removed). The capacitors (470µF & 0.1µF) on the TPL7407L COM pin are connected regardless of R41 to R47 presence. Therefore the charging, discharging, and leakages of the capacitors must be considered. Each output pin has an internal diode to the COM pin. Testing for channel 1 will be described; test other channels by using a different pin on the J1(input) and J2(output) connectors.

Channel Tested	J1(Input)-pin	J2(Output)-pin
CH 1	J1-1	J2-1
CH 2	J1-2	J2-2
CH 3	J1-3	J2-3
CH 4	J1-4	J2-4
CH 5	J1-5	J2-5
CH 6	J1-6	J2-6
CH 7	J1-7	J2-7

Relay supply is connected to TB1 pin 4; the Relay supply sense line can also be connected to TB1-pin4. Alternatively the sense line can be connected to J2 pin 8. The relay supply is the same node as the TPL7407L COM (pin 9).

Ground power and ground sense connection can be made to TB1 pins 2 and 3. An alternative ground sense can be made at J1 pin 8.

Warning: All tests that supply current should be limited to the data sheet limit of 600mA. Input pin voltage should be limited to 30V and output pin voltage should be limited to 40V.

Input parameter VI(on) and VI(off) Channel 1 Test Setup and Typical Results

Board setup: Sweep input voltage on J1-1; Set Output J2-1 and Relay Supply to 24V, measure output current on J2-1 [current clamp on measurement range of 10mA is recommended].

Note: any difference between voltage on J2-1 and Relay Supply(TB1-4) will affect low current accuracy with Standard board.

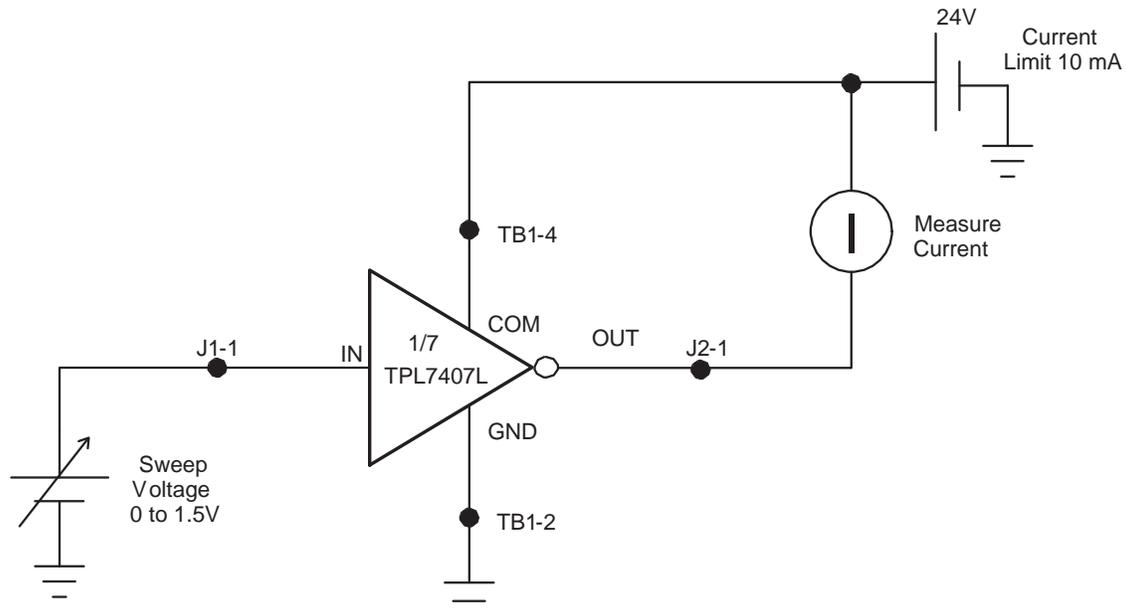


Figure 3. VI(on) and VI(off) Schematic

Input Parameter I_(on) Channel 1 Test Setup and Typical Results

Input current is a function of input voltage alone. The output load impedance and termination voltage have no impact on the results.

Board setup: Sweep input voltage on J1-1. Measure input current on J1-1. Optionally, Relay supply can be connected to 24V.

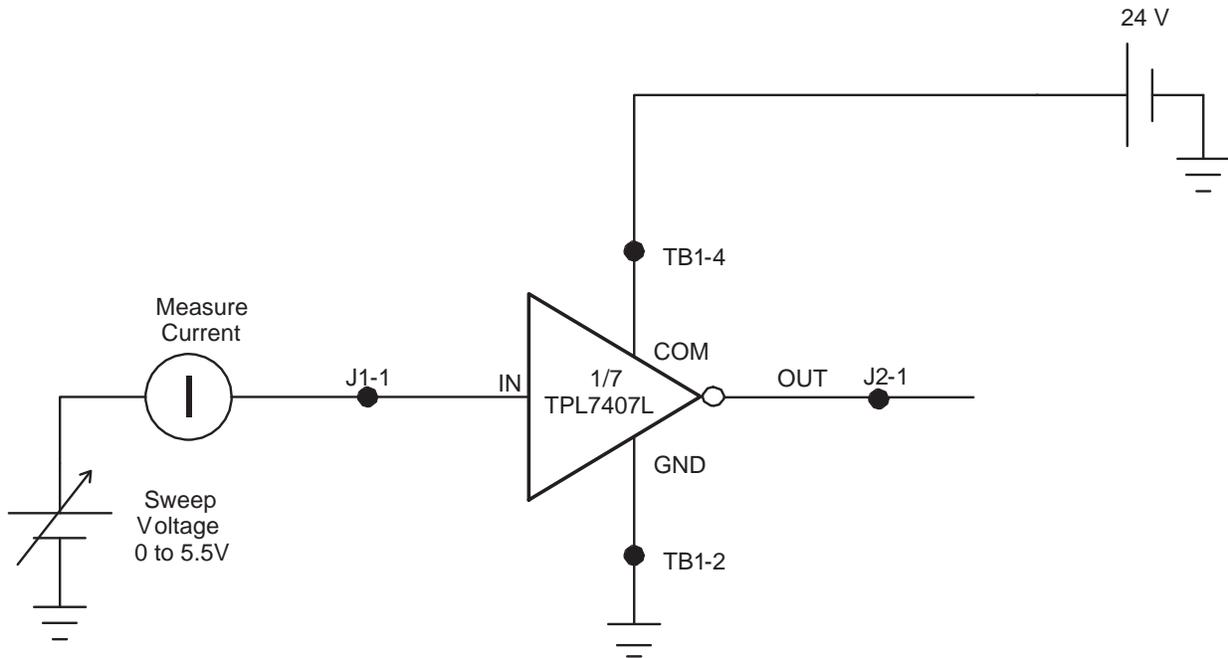


Figure 4. I_(on) Schematic

Input Parameter $I_{(off)}$ Channel 1 Test Setup and Typical Results

Input current with zero input voltage will be very low. A pico-amp meter is recommended. This is a signal point test.

Standard board setup: Set input voltage on J1-1 to 0V. Measure input current on J1-1. Optionally, output J2-1 and Relay Supply can be set to 24V.

Modified board setup: Sweep CH1 voltage on J1-1; Set Output J2-1 and Relay Supply to 24V, measure current on J1-1. The return lead of the pico-amp meter must be at board ground potential.

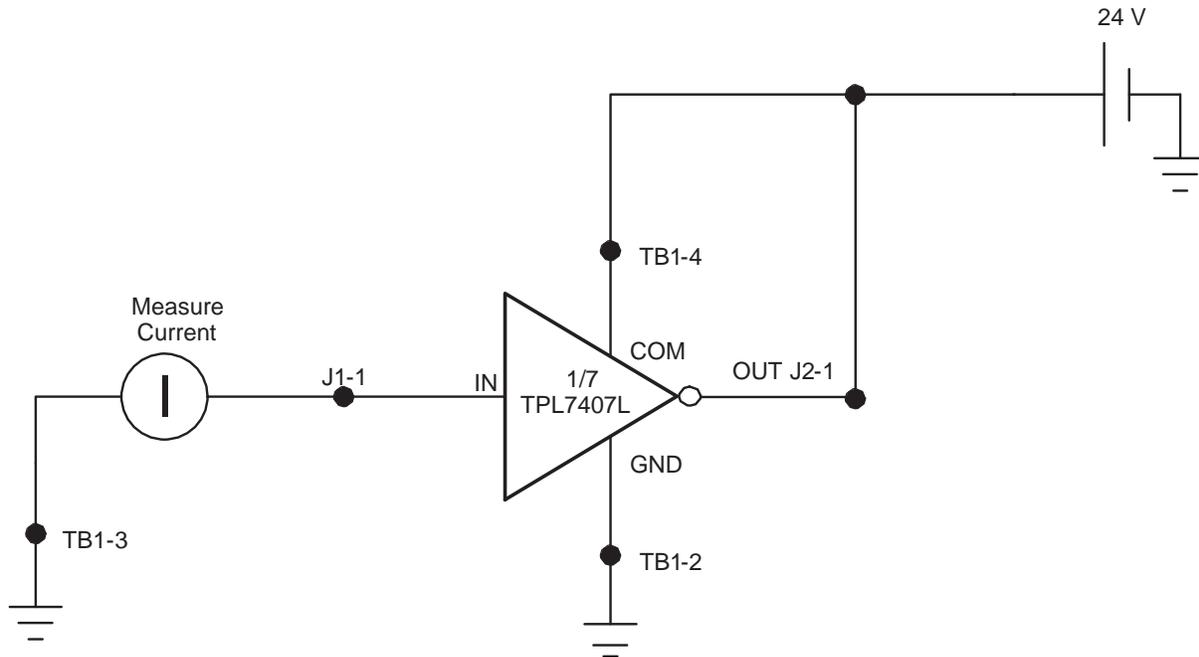


Figure 5. $I_{(off)}$ Schematic

Output Parameter VOL Channel 1 Test Setup and Typical Results

This parameter was called collector emitter saturation voltage on the original TPL7407L device.

The data sheet has specifications for input voltages of 1.8V - 5V.

Board setup: Sweep output current on J2-1. Set desired input voltage on J1-1 [1.8V - 5V, and other voltages]. Disconnect the relay supply on TB1-4. Measure output voltage on J2-1 (kelvin connections at J2-1 and ground are highly recommended for accurate results).

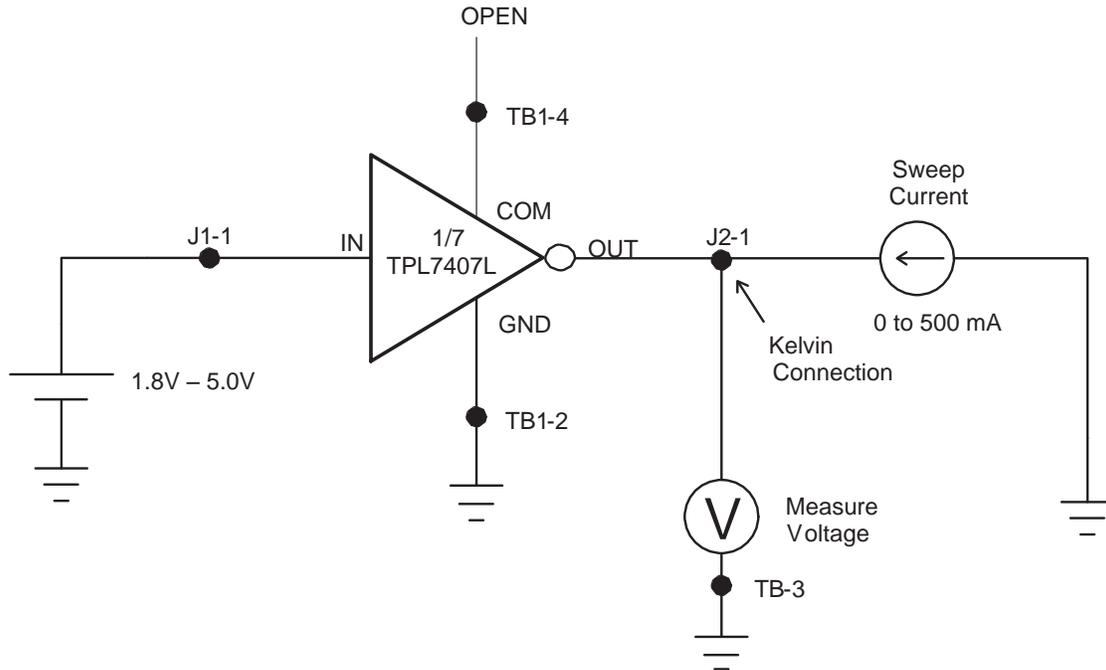


Figure 6. VOL Schematic

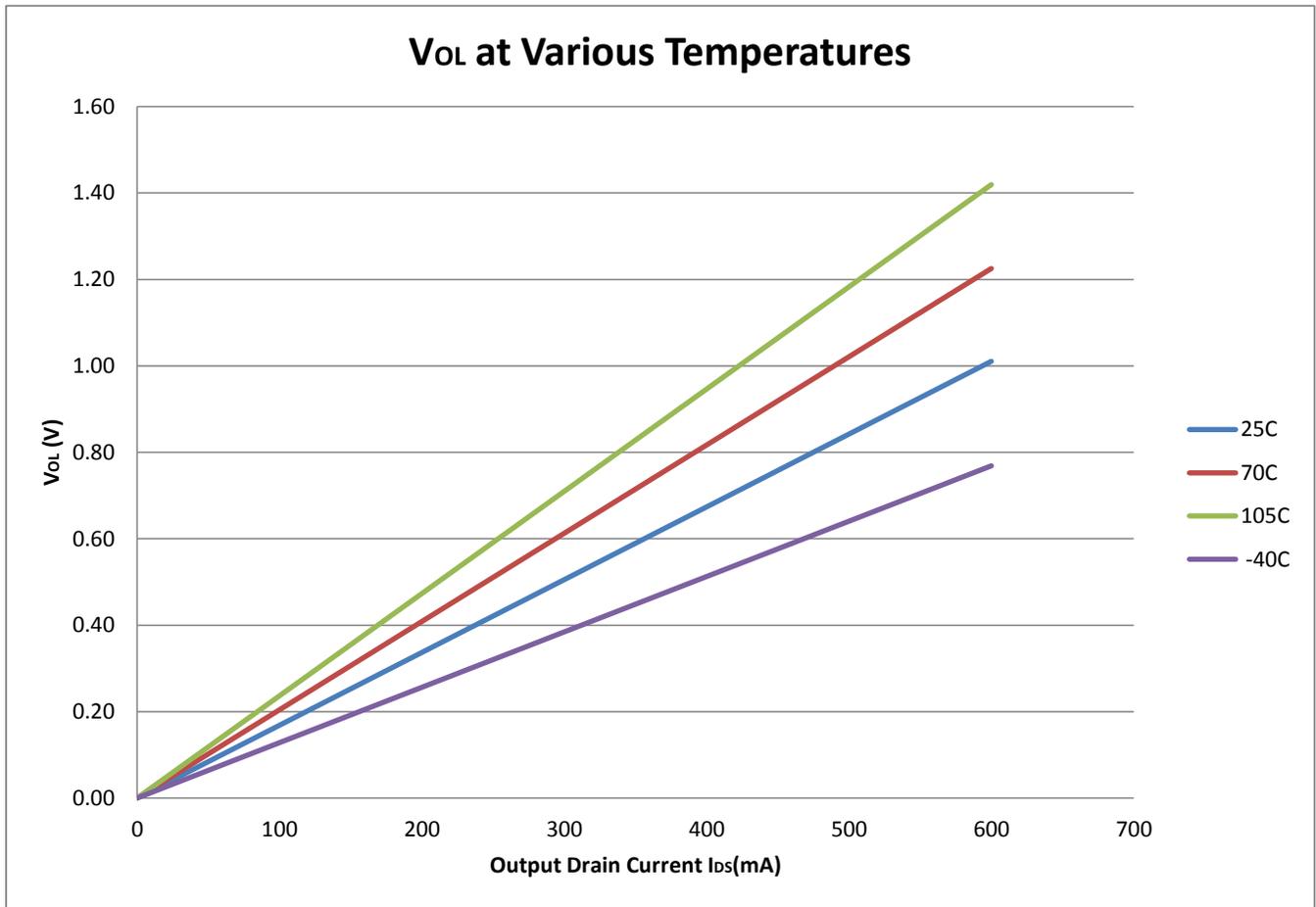


Figure 7. VOL vs IOL

Output Parameter IOU_{T(on)} Channel 1 Test Setup and Typical Results

Board setup: Sweep input voltage on J1-1. Set output voltage on J2-1 to 0.4V. Disconnect the relay supply on TB1-4. Measure output current on J2-1 (sense connections at J2-1 and ground are highly recommended to keep 0.4V on the EVM regardless of line losses in wires and current meter).

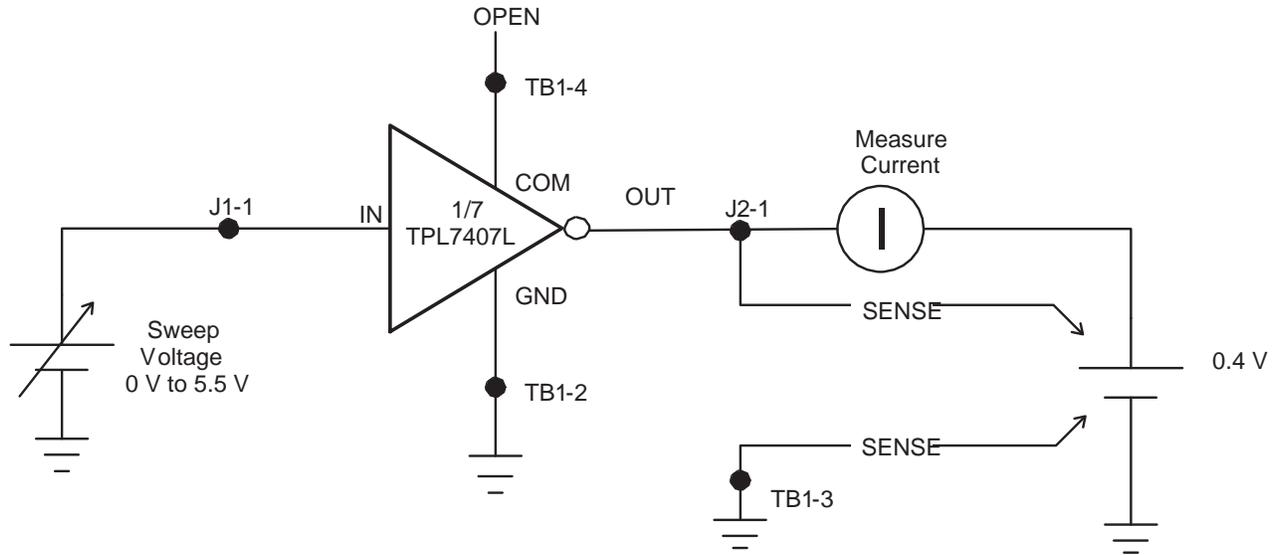


Figure 8. IOU_{T(on)} Schematic

Switching Parameter t_{PHL} 3.3V 50Ω Channel 1 Test Setup and Typical Results

Board setup: The TPL7407Land TPL7407LEVM are primarily designed for slow responding loads like relays, stepper motors, and DC lab equipment; however, the TPL7407Lrise/fall times and propagation delays are short. Therefore line termination and short wires are important for signal quality. The waveform below uses a 50 ohm cable “T” tapped within 3 cm of the J1-Input connector and terminated at the oscilloscope set to 50 ohm input impedance. This input is used as the scope trigger. A locally grounded 10X scope probe is used to measure the input signal and the same probe was used to measure the output on J2-1. A pull up resistor of 50Ω is connected between the output (J2-1) and Relay supply (J2-8). Set scope trigger for rising edge. Pulse generator is 10% duty cycle 100kHz 3.3V logic level signal.

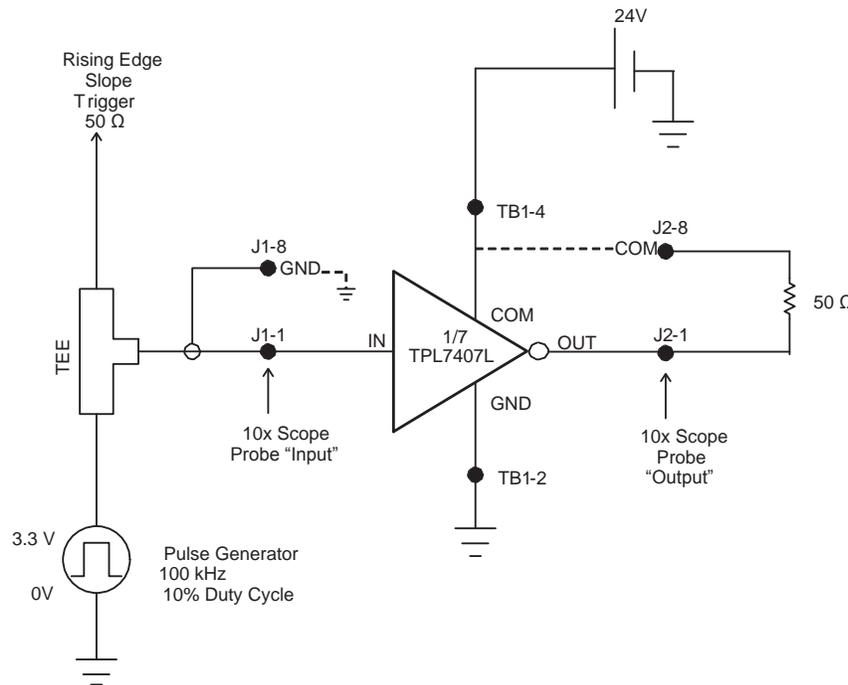


Figure 9. T_{PHL} Schematic

Switching Parameter t_{PLH} 3.3V 50Ω Channel 1 Test Setup and Typical Results

Board setup: The TPL7407Land TPL7407LEVM are primarily designed for slow responding loads like relays, stepper motors, and DC lab equipment; however, the TPL7407Lrise/fall times and propagation delays are quite short. Therefore line termination and short wires are important for signal quality. The waveform below uses a 50 ohm cable “T” tapped within 3 cm of the J1-Input connector and terminated at the oscilloscope set to 50 ohm input impedance. This input is used as the scope trigger. A locally grounded 10X scope probe is used to measure the input signal and the same probe was used to measure the output on J2-1. A pull up resistor of 50Ω is connected between the output (J2-1) and Relay supply (J2-8). Set scope trigger for falling edge. Pulse generator is 10% duty cycle 100kHz 3.3V logic level signal.

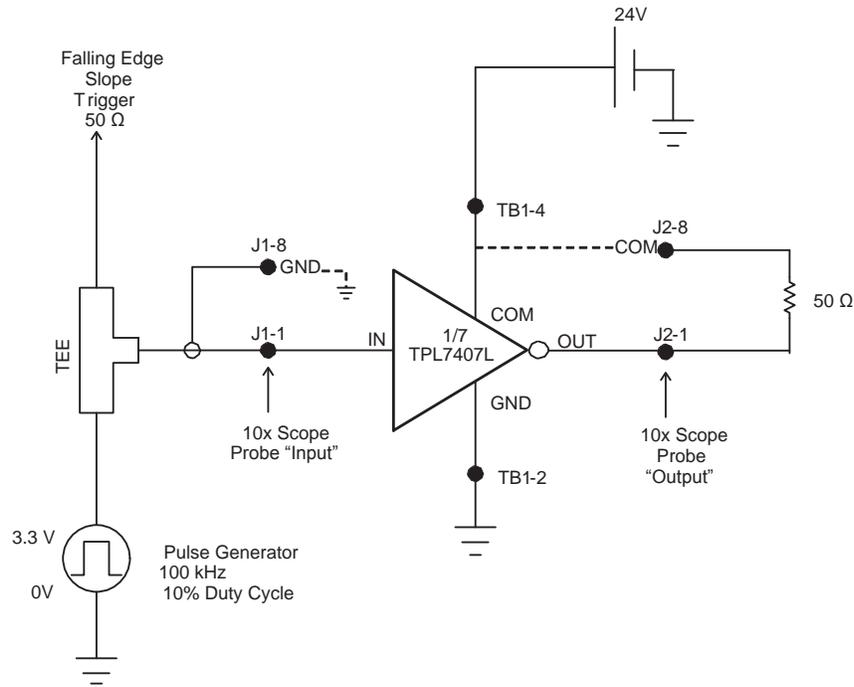


Figure 10. T_{PLH} Schematic

Switching Parameter R_{IN} Channel 1 Test Setup and Typical Results.

The data to calculate R_{IN} , the DC input resistance, was recorded during the II(on) test. The input resistance is simply input voltage divided by input current.

Free-wheeling Diode Parameter VF channel 1 Test Setup and Typical Results

Board setup: Sweep output current on J2-1. Set Relay supply voltage to 0V. On standard boards the X axis (output current) will need to be compensated for coil current flow. The real diode current is approximately $X - VF/2,880\Omega$. Measure output current on J2-1 (Kelvin connections at J2-1 and relay supply are highly recommended for accurate results).

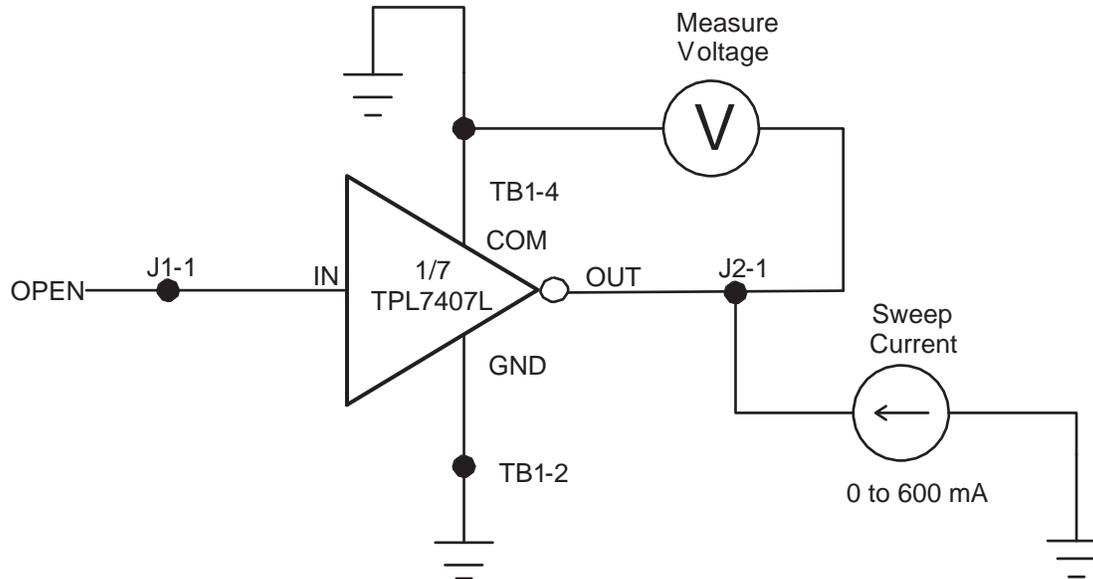


Figure 11. VF Schematic

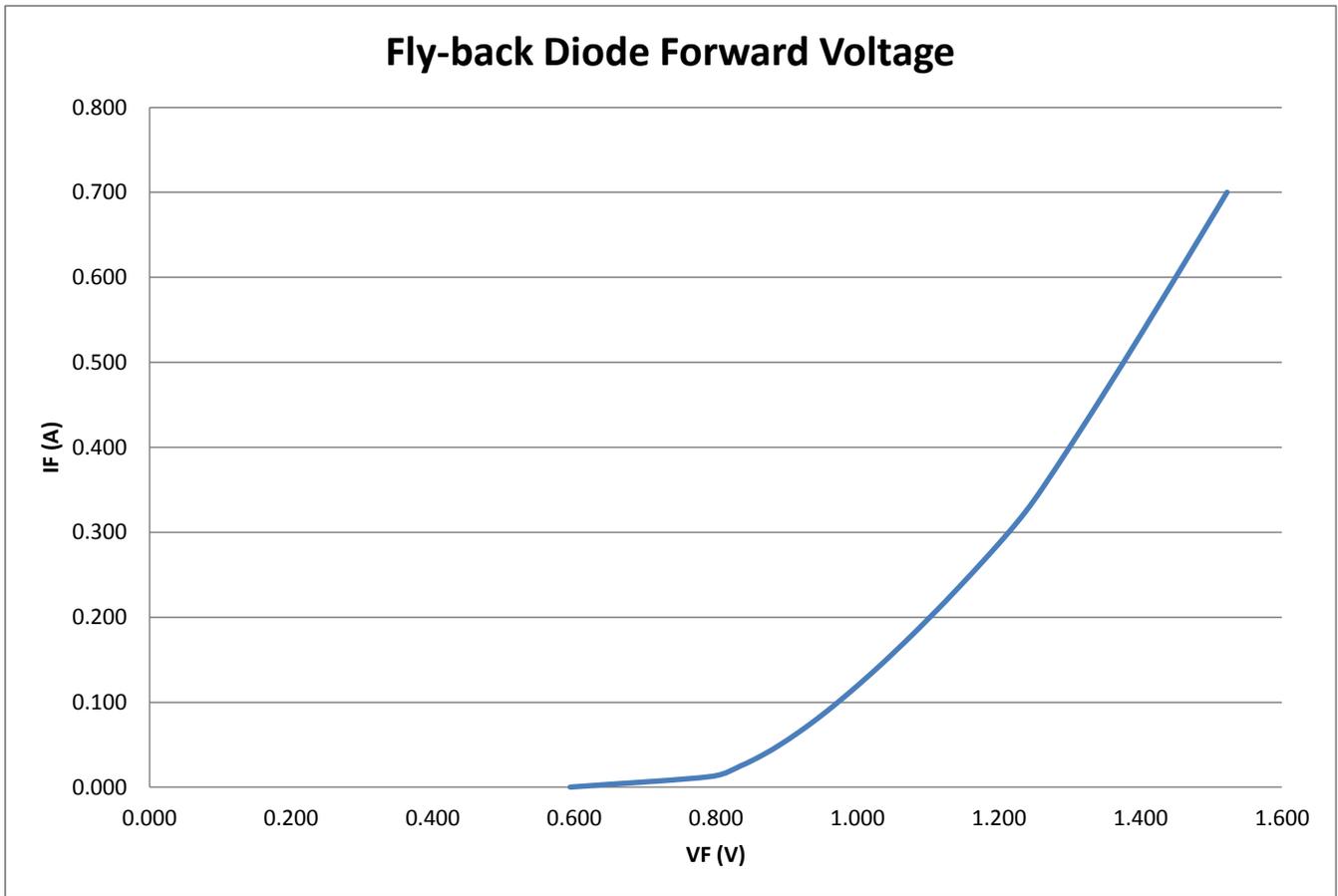


Figure 12. VF = Diode(V) vs Diode(I)

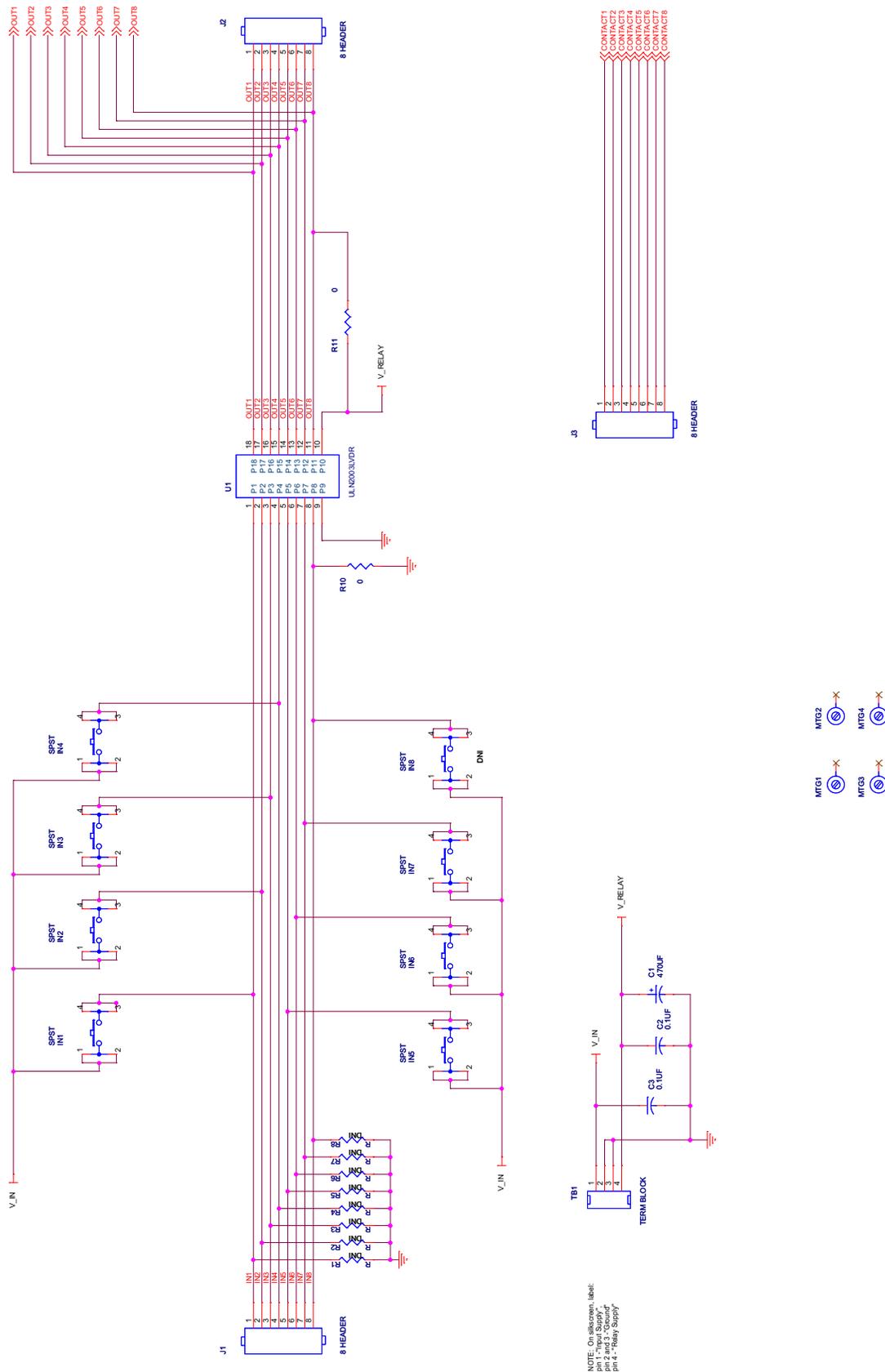


Figure 13. Full Schematic

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